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(54) Title: NON-REACTIVE HOT-MELT ADHESIVE WITH SPECIFIC RESIN

(57) Abstract: The invention pertains to a non-reactive hot-melt adhesive comprising - 10-90 wt.%, calculated on the weight of the adhesive, of amorphous thermoplastic resin which is compatible with polylactic acid, wherein the amorphous thermoplastic resin is a random copolymer of lactic acid and further reactive monomer, - 10-90 wt.%, calculated on the weight of the adhesive, of a polylactic acid polymer unit (PLAU) selected from poly-L-lactic acid (PLLAU) and poly-D-lactic acid (PDLAU), the unit having a number average molecular weight of at least 0.7 kg/mol. In one embodiment the non-reactive hot-melt adhesive further comprises 0.5-20 wt.%, preferably 1-10 wt.%, calculated on the weight of the first PLAU, of a second polylactic acid polymer unit (PLAU) selected from poly-L-lactic acid (PLLAU) and poly-D-lactic acid (PDLAU), the unit having a number average molecular weight of at least 0.75 kg/mol, wherein when the first PLAU is PLLAU, the second PLAU is PDLAU and when the first PLAU is PDLAU, the second PLAU is PLLAU. The non-reactive hot-melt according to the invention has desirable properties. It combines, int.al., a good adhesive performance with a good storage stability resulting from a low cold-flow, and may have a short set time.



Non-reactive hot-melt adhesive with specific resin

Filed of the Invention

The invention relates to a non-reactive hot-melt adhesive comprising a specific resin. The invention also pertains to a method for the manufacture of such non-reactive hot-melt adhesive, and its use.

Background of the Invention

As used herein, "hot-melt adhesive" refers to a thermoplastic polymer composition that is heated to obtain a liquid of flowable viscosity, and after application to a substrate, cooled to obtain a solid. After the hot-melt adhesive solidifies upon cooling to a temperature below its melt temperature or below its solidification transition temperature, an adhesive bond is formed between the substrate and the adhesive material. As essentially no chemical bonds are formed between the adhesive and the substrate upon which the adhesive is applied, the hot-melt adhesive may be referred to as a non-reactive hot-melt adhesive.

Hot-melt adhesives are often used to bond two substrates together so as to maintain the two substrates in a fixed relation to each other. Hot-melt adhesives are also used in articles that include a nonwoven layer to bond the nonwoven layer and a polymer film layer together. Hot-melt adhesives are further used to adhere packaging constructions e.g. bag, box, carton, case and tray together to construct the package, close the package or both. They are also used as pressure-sensitive adhesives for tapes and labels.

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US5753724 describes a hot-melt adhesive composition comprising a polylactic acid polymer and a resin grade or high molecular weight thermoplastic polyester, which is, e.g., a thermoplastic polyester urethane, a polylactic acid resin or a PHBV thermoplastic resin.

W02008/044651 describes a biodegradable polylactic acid-based adhesive containing a polylactic acid resin composition which is substantially composed of a crystalline polylactic acid, a non-crystalline polylactic acid and a plasticizer.

W02005/056680 describes a biodegradable hot-melt adhesive for use in medical applications, which has a melting point in the range of 57-100°C and which is based on polymer blends consisting of caprolactone copolymers or caprolactone copolymers and polycaprolactone.

US2009/0234042 describes transparent blends of polypropylene carbonate with polylactic acid. The blends are used, e.g., in packaging in the form of foams or solid or rigid films. Use as an adhesive is not described.

US5252642 describes a degradable impact modified polylactic acid which comprises a blend of a physical mixture of polylactic acid and blend-compatible elastomer. Lactic acid, lactide, and lactic acid oligomers may be added as plasticizers. The compositions are processed by melt-processing to form disposable polymer articles.

A non-reactive hot-melt adhesive has to meet a number of requirements to be suitable for commercial application. In the first place, as will be evident, the adhesion properties of the adhesive upon use have to be good. Loss of

adhesion can cause, e.g., opening of packages, which is unacceptable both during and after production. Further, hot-melt adhesives are conventionally provided in the form of granules, which will be molten before use. These granules have to be stable during storage. That is, the granules cannot adhere to each other to a too large extent, as this will impede proper handling of the granules. To obtain this feature, it is important to ensure that the hot-melt adhesive does not show flow at room temperature.

A further important property of a hot-melt adhesive is the set time, that is, the time required by the adhesive to form a bond with the substrate. The set time is important in commercial operation, because it governs the time required to press the two substrates sandwiching the adhesive together. Set time may be of the order of seconds.

On the other hand, while the set time often has to be very short, the adhesive has to show some open time. The open time is the time after application of the adhesive at high temperature during which the adhesive still has flow properties. This is the time frame after application of the adhesive onto the carrying substrate during which the covering substrate can be applied while obtaining good adhesion.

A further property which may be desirable for hot-melt adhesives is a certain degree of biodegradability. Where the hot-melt adhesive is used in the manufacture of objects which are to be composted, it is important that the adhesive can be degraded within the same time frame as the rest of the object. This feature may be of particular relevancy where the

hot-melt adhesive is used in the manufacture of packaging material.

Further, it is preferred for the hot-melt adhesive to be at least partially derivable from renewable resources.

There is need in the art for a non-reactive hot-melt adhesive which combines a good adhesive performance with a good storage stability resulting from a low cold-flow, and in some embodiments a short set time, wherein the adhesive is at least partially based on polymers which can be prepared from renewable resources. The present invention seeks to provide such an adhesive.

Summary of the Invention

The present invention provides a non-reactive hot-melt adhesive comprising

- 10-90 wt.%, calculated on the weight of the adhesive, of amorphous thermoplastic resin which is compatible with polylactic acid, wherein the amorphous thermoplastic resin is a random copolymer of lactic acid and further reactive monomer,

- 10-90 wt.%, calculated on the weight of the adhesive, of a polylactic acid polymer unit (PLAU) selected from poly-L-lactic acid (PLLAU) and poly-D-lactic acid (PDLAU), the unit having a number average molecular weight (Mn) of at least 0.75 kg/mol,

wherein number average molecular weight (Mn) as used herein is determined by Gel Permeation Chromatography (GPC) using chloroform as solvent and running phase and polystyrene standard, and

wherein as used herein amorphous thermoplastic resin is defined as a thermoplastic resin which has an enthalpy of melting of at most 2.0 J/gram as determined by Differential Scanning Calorimetry.

Also provided is a method for manufacturing a non-reactive hot-melt adhesive according to the invention, the method comprising the steps of combining and mixing the thermoplastic resin, the first PLAU, and, if present the second PLAU, to form a liquid composition

Further provided is a method for arranging substrates in a fixed position with respect to each other, the method comprising the steps of:

applying an amount of a non-reactive hot-melt adhesive according to the invention in liquid form onto a surface of a first substrate;

applying a surface of a second substrate onto the amount of non-reactive hot-melt adhesive; and,

cooling the assembly of substrates and non-reactive hot-melt adhesive to a temperature below the melting point of the non-reactive hot-melt adhesive.

Detailed Description of the Invention

The hot-melt adhesive of the present invention comprises PLA which can be derived from renewable resources. Further, PLA is biodegradable, and, depending on the nature of the amorphous thermoplastic resin and the other components in the composition, a fully biodegradable composition may be obtained. Further, the adhesive combines a good adhesive performance with a good storage stability resulting from a

low cold-flow, and may have a short set time. Further advantages of the present invention and specific embodiments thereof will become apparent from the further specification.

5 The non-reactive hot-melt adhesive of the present invention comprises a polylactic acid polymer unit (PLAU). Within the context of the present specification, the term polylactic acid polymer unit (PLAU) refers to a polymer unit comprising at least 90 wt.% of lactic acid monomers, in particular at least 95 wt.%, more in particular at least 98 wt.% of lactic acid monomers. The lactic acid monomers in the PLAU may originate from lactic acid itself but are preferably obtained from lactide, the cyclic dimer of lactic acid. It is well-known to use lactide in the production of polylactic acid (co)polymers, by means of ring-opening polymerization techniques.

Within the context of the present specification, a poly-L-lactic acid unit (PLLAU) is defined as a PLAU in which at least 90% of the lactic acid monomers are L-lactic acid monomers, in particular at least 95%, more in particular at least 98%. Conversely, within the context of the present specification, a poly-D-lactic acid unit (PDLAU) is defined as a PLAU in which at least 90% of the lactic acid monomers are D-lactic acid monomers, in particular at least 95%, more in particular at least 98%. For the effect of the present invention, higher percentages are preferred as it is believed that combining units with a higher stereochemical purity leads to improved set times.

As indicated above, the non-reactive hot-melt adhesive composition comprises 10-90 wt.%, preferably 30 - 70 wt.% and more preferably 40 - 60 wt.%, calculated on the weight of the

adhesive, of a polylactic acid polymer unit (PLAU) with a number average molecular weight of at least 0.75 kg/mol. This PLAU will in the following also be indicated as the first PLAU, as the composition can in some embodiments also contain a second PLAU.

Therefore, in one embodiment, the hot-melt adhesive according to the invention further comprises 0.5-20 wt.% calculated on the weight of the first PLAU, of a second polylactic acid polymer unit (PLAU) selected from poly-L-lactic acid (PLLAU) and poly-D-lactic acid (PDLAU), the unit having a number average molecular weight of at least 0.75 kg/mol, wherein when the first PLAU is PLLAU, the second PLAU is PDLAU and when the first PLAU is PDLAU, the second PLAU is PLLAU.

It has been found that the presence of this second PLAU leads to a decreased set time, which is advantageous in many applications.

In this embodiment of the invention, the second PLAU is present in an amount of 0.5-20 wt.% of the first PLAU. If the amount of second PLAU is below 0.5 wt.%, the decrease in set time of the composition generally not be obtained. On the other hand, if the amount of second PLAU is above 20 wt.%, its presence may start to interfere with the properties of the composition resulting, e.g., in a low-shear viscosity which is too high.

It may be preferred for the second PLAU to be present in an amount of 1-10 wt.%, more preferably 2 - 8 wt.% and most preferably 3 - 6 wt%, of the first PLAU.

The first PLAU is PLLAU or PDLAU, with the second PLAU having the opposite stereochemistry. While both PLLAU and PDLAU are

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5 viable options for the first PLAU from a technical point of view, it may be preferred for the first PLAU to be PLLAU and the second PLAU to be PDLAU. This is because PLLA is derived from L-lactic acid, which is has a higher availability on the market than D-lactic acid.

Both PLA units have a number average molecular weight (M_n) of at least 0.75 kg/mol. If the M_n of either PLA unit is below this value, the effect of the present invention will not be obtained.

The first PLAU preferably has a M_n in the range of 0.75 to 10 kg/mol. When the M_n of the first PLAU is too high, it may become difficult to formulate a composition with an acceptable viscosity. On the other hand, an M_n which is higher than the lower limit of 0.75 kg/mol may help to reduce the set time of the composition. It may be preferred for the first PLAU to have an M_n in the range of 1.5 to 7.5 kg/mol, and more preferred in the range of 2.0 - 3.0 kg/mol, and most preferably 2.5 kg/mol.

The second PLAU, if present, preferably has a M_n in the range of 0.75 to 10 kg/mol. When the M_n of the second PLAU is too high, it may become difficult to ensure a homogeneous presence of the second PLAU in the adhesive composition. Further, the viscosity of the end product may become too high. On the other hand, an M_n which is higher than the lower limit of 0.75 kg/mol may help to reduce the set time of the composition. It may be preferred for the second PLAU to have an M_n in the range of 1.5 to 7.5 kg/mol and more preferred in the range of 2.5 - 4.0 kg/mol, most preferably 3.5 kg/mol.

In one embodiment it is preferred for the the values of the Mn of the first and the second PLAU in the adhesive to be in the same range. More precisely, it is preferred for the Mn of the largest PLAU to be at most 2.5 kg/mol larger than the Mn of the smallest PLAU, in particular at most 2.0 kg/mol. It may be preferred for the Mn of the largest PLAU to be at most 1.5 kg/mol larger than the Mn of the smallest PLAU. It has appeared that matching the molecular weights of the two types of PLAU in this manner helps to ensure that the composition has an adequate viscosity.

Within the context of the present specification, the number average molecular weight Mn is the statistical average molecular weight of all the polymer chains in the sample, and is defined by:

$$Mn = \frac{\sum NiMi}{\sum Ni}$$

where Mi is the molecular weight of a chain and Ni is the number of chains of that molecular weight. Mn can be predicted by polymerization mechanisms and is measured by methods that determine the number of molecules in a sample of a given weight; for example, colligative methods such as end-group assay. If Mn is quoted for a molecular weight distribution, there are equal numbers of molecules on either side of Mn in the distribution. In the context of the present specification Mn is determined by Relative Gel permeation chromatography (GPC) using chloroform as solvent and running phase, using polystyrene as a reference. Detection is via Refractive Index.

The PLA units used in the composition according to the invention may be in the form of, respectively PLLA and PDLA

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5 polymers. It is also possible, however, that the units are present in polymers which also encompass other units. For example, a PLLA unit can be present as a block in a polymer which also comprises blocks of lactic acid polymer which contains less than 90% of units of a single type of stereochemistry. An example of such a block would be a block obtained by polymerization of meso-lactide (which contains 50% L-lactic acid monomer and 50% D-lactic acid monomer). In general, the PLAU is present in a polymer which comprises at least 70 wt.% of monomers derived from lactic acid, either in the PLAU or in the polymer but not in the PLAU. It may be preferred for the PLAU to be present in a polymer which comprises at least 80 wt.% of monomers derived from lactic acid, in particular at least 90 wt.%. It is noted that in the context of the present specification the polymer comprising the PLAU and the amorphous thermoplastic resin are separate components.

0 In one embodiment, the PLAU is present in a polymer of which it makes up at least 80 wt.%, in particular at least 90 wt.%.

25 In general, the first PLAU and the second PLAU, if present, are present in different polymers, as it is believed that this makes the adhesive composition easier to manufacture and allows more flexibility in tuning the composition to meet specific needs for the end composition.

30 The non-reactive hot-melt adhesive according to the invention comprises an amorphous thermoplastic resin which is a random copolymer of lactic acid, preferably derived from lactide, and one or more further reactive monomers.

Within the context of the present specification an amorphous thermoplastic resin is defined as a thermoplastic resin which has an enthalpy of melting of at most 2.0 J/gram. This is determined via DSC.

It is preferred for the amorphous thermoplastic resin to have an enthalpy of melting of at most 1.0 J/gram, as a lower degree of crystallinity, as is evidenced from a lower enthalpy of melting, is believed to prevent the adhesive from becoming brittle and to result in a hot-melt adhesive with better adhesion properties.

Within the context of the present specification, the term thermoplastic polymer refers to a polymer which is solid at room temperature, becomes pliable, moldable, or liquid above a specific temperature, and returns to the solid state below said temperature, and wherein these heating and cooling steps can be repeated.

Within the context of the present specification, the term "compatible with polylactic acid" means that a mixture of the amorphous thermoplastic resin and the PLA units as they will occur in the hot-melt adhesive is stable both under melting conditions and at room temperature. Stable means that upon storage at room temperature for 30 days and under melting conditions for 72 hours no phase separation occurs and the emulsion or suspension remains homogeneous.

It is within the scope of the skilled person to determine whether the thermoplastic polymer is compatible with polylactic acid by simple tests, e.g., by placing an amount, e.g., 50 ml of the adhesive composition in a glass jar in an oven at a temperature above the melting temperature (without

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stirring), and visually assessing the properties of the product. The temperature used in the test should correspond to a temperature at which the adhesive may be used in commercial operation.

The amorphous thermoplastic resin generally has a Mn in the range of 10 to 100 kg/mol, depending on the nature of the resin. If the molecular weight is too low, the adhesive properties of the adhesive composition may be unacceptable.

If the molecular weight is too high, the viscosity of the composition may be unacceptably high. It may be preferred for the Mn to be in the range of 10 to 50 kg/mol, in particular in the range of 10 to 30 kg/mol, and most particular approximately 15 kg/mol.

The respective amounts of thermoplastic polymer and PLA units may vary within wide ranges. In one embodiment, the non-reactive hot-melt adhesive of the invention comprises 20-80 wt.%, in particular 30-70 wt.%, calculated on the weight of the adhesive, of amorphous thermoplastic resin and 20-80 wt.%, in particular 30-70 wt.%, calculated on the weight of the adhesive, of the total of first and second PLA units.

In some embodiments, it may be preferred for the non-reactive hot-melt adhesive of the invention to comprises 40-60 wt.%, calculated on the weight of the adhesive, of amorphous thermoplastic resin and 40-60 wt.%, calculated on the weight of the adhesive, of the total of first and second PLA units.

In the present invention, the amorphous thermoplastic resin is a random copolymer of lactic acid and further reactive monomer. The random copolymer has an enthalpy of melting of at most 2.0 J/g, as specified above.

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Within the context of the present specification further reactive monomer is defined as a monomer which is not a lactic acid monomer and which is capable of polymerizing with lactic acid monomers (generally in the form of lactide) to form a polymer.

Suitable further reactive monomers may be selected from monomers having a single alcohol group and a single carboxylic acid group. Representative examples of such monomers are glycolic acid (often in the form of glycolide, the cyclic diester of glycolic acid), lactones, and mandelic acid.

Interesting further reactive monomers may be selected from monomers having two alcohol groups in combination with monomers having two carboxylic acid groups. These two monomers should be combined in approximately a 1:1 molecular ratio, e.g., between 0.8:1 and 1.2:1, whereby a slight excess of the dialcohol monomer is preferred. Therefore, in one embodiment the molar ratio between diol and dicarboxylic acid is in the range of above 1:1 to 1.2:1, in particular above 1:1 to 1.1:1.

Examples of suitable monomers having two hydroxyl groups are ethane diols, propane diols, butane diols, pentane diols such as neopentyl glycol, and hexane diols, ethylene glycol, diethylene glycol, and triethylene glycol.

Examples of suitable dicarboxylic acids are succinic acid, fumaric acid, adipic acid, maleic acid, 2,5-furandicarboxylic acid, and malic acid.

In general, the reactive monomer has between 2 and 20 carbon atoms (C2-C20), more specifically between 2 and 10 carbon

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atoms (C2-C10). In all cases, the C-chains may be straight or branched and include also other suitable substituents.

At this point in time copolymers of lactic acid (generally derived from lactide), and one or more further reactive monomers selected from the group of glycolic acid (often in the form of glycolide, the cyclic diester of glycolic acid), lactones, in particular caprolactone, and mandelic acid are considered preferred. The use of a copolymer of lactic acid and caprolactone as further reactive monomer is considered particularly preferred. This embodiment is discussed in more detail below.

Combinations of two or more polymers may also be used.

The random copolymer of lactic acid and further reactive monomer generally comprises 10-90 wt.% of lactic acid monomer and 90-10 wt.% of further reactive monomers. It may be preferred for the random copolymer to comprise at least 20 wt.% of lactic acid monomer, in particular at least 40 wt.% of lactic acid monomer, in some embodiments at least 50 wt.% of lactic acid monomer. In one embodiment the polymer comprises at most 80 wt.% of lactic acid monomer. The balance is always made up of further reactive monomer.

The lactic acid monomers that are present in the thermoplastic resin used in the present invention can be derived from D-lactic acid, L-lactic acid, and combinations thereof. The use of L-lactic acid may be preferred in view of its wide availability.

In one embodiment the amorphous thermoplastic resin is a copolymer of lactic acid and caprolactone as further reactive monomer.

The general ranges indicated above for the random copolymer of lactic acid and further reactive monomer also apply to this copolymer of lactic acid and caprolactone. For this specific copolymer is it preferred for it to comprise 40-80 wt.% of lactic acid monomer, in particular L-lactic acid monomer, and 60-20 wt.% of caprolactone. It is considered particularly preferred for this copolymer to comprise 50-70 wt.% of lactic acid monomer, in particular L-lactic acid monomer, and the balance caprolactone.

As regards the molecular weight: while the general ranges indicated above for the amorphous thermoplastic resin also apply to this specific copolymer, it may be preferred for the copolymer of lactic acid monomer and caprolactone to have a Mn in the range of 10 to 50 kg/mol, in particular 10-40 kg/mol.

While the general ranges given above also apply, where a copolymer of caprolactone and lactic acid is used in the present invention, it is preferred for the non-reactive hot-melt adhesive of the invention to comprise 40-60 wt.%, calculated on the weight of the adhesive, of amorphous thermoplastic resin and 40-60 wt.%, calculated on the weight of the adhesive, of first and, if present, second PLA units.

In general, the thermoplastic resin and the polylactic acid polymer units together will make up at least 50 wt.% of the adhesive composition according to the invention. As the thermoplastic resin and the polylactic acid polymer units

together provide a non-reactive hot-melt adhesive with desirable properties, it is generally preferred for the thermoplastic resin and the polylactic acid polymer units together to make up at least 60 wt.% of the adhesive composition, more in particular at least 70 wt.%, even more in particular at least 80 wt.%.

The hot-melt composition can comprise additives known in the art for addition to hot-melt adhesive compositions. Suitable additives include tackifiers which improve the adhesion properties of the composition, plasticizers to reduce the Tg of the composition, waxes to help to improve the set time and reduce the viscosity, oils to adjust the viscosity, fillers to provide volume to the composition, stabilizers such as antioxidants to increase the stability of the composition, coloring agents, rheology agents to adjust flow behavior, etc.

These components and their effects are known in the art, and require no further elucidation here.

Useful tackifiers are of the synthetic rosin resin type (with examples like Permalyne 5095® and Permalyne 5110®), the aliphatic C5/C9 resins type (with examples like Piccotac 9095-E®, Piccotac 8090-E®, Piccotac 7590®, Piccotac 6095®, Piccotac 1125® and Piccotac 5090®), the hydrogenated rosin esters type (with examples like Foralyn 5020-F®, Rosin ester, Sylvatac RE12®, Sylvatac RE 5S® and Sylvatac RE 85S®), the terpene phenolic type (with examples like Sylvares TP115P® and Sylvares TP2040HM®) and the styrenated phenolic resin type (with examples like Zonatac NG98®). Useful plasticizers are triethyl-citrate (such as in Citrofol Al Regular®), tris(2-ethylhexyl)O-acetylcitrate (such as in Citrofol

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AHII®), tributyl-citrate (such as in Citrofol BI), and Tributyl O-cetylcitrate ATBC (such as in Citrofol BII®). Useful waxes are paraffin wax, microcrystalline wax and synthetic wax. Useful fillers and/or rheology modifiers are chalk, barite, quartz, gypsum, calcium oxide, magnesium oxide, silica. Suitable stabilizers are anti-oxidants, such as: Irganox 1010 (Pentaerythritol Tetraakis(3-(3,5-di-tert-butyl-4-hydroxyphenyl)propionate). Suitable acid scavengers are carbodiimides.

The hot-melt adhesive of the present invention generally has a melting temperature in the range of 80-220°C, more in particular in the range of 120-200°C. If the melting temperature is too low, the adhesive may melt under conditions of use. High melting temperatures may be unattractive in view the energy consumption required and application stability.

The hot-melt adhesive of the present invention generally has a set time of less than 15 seconds, in particular less than 10 seconds. Set time may be even shorter, such as less than 8 seconds. Set time can be determined as described in Example 1.

The hot-melt adhesive of the present invention generally has a viscosity below 8000 mPa.s, preferably below 4000 mPa.s, in particular below 2000 mPa.s. The viscosity generally is above 500 mPa.s. Below 500 mPa.s, the composition may be too liquid at application temperature, which would result in "running" of the adhesive. A viscosity above 8000 mPa.s may be too high to allow easy application of the hot-melt adhesive. Viscosity can be determined in accordance with ASTM-D 3236-15, at a temperature of 175°C using spindle 21.

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5 The adhesive composition can be manufactured by combining the
various ingredients in the liquid phase. In one embodiment,
in a first step the thermoplastic resin is provided in the
liquid phase, and the PLAU is added thereto, either in the
solid phase or in the liquid phase, to form a liquid
composition. Where both a first PLAU and a second PLAU are
used, it is preferred in a first step to combine the
thermoplastic resin and one of the first or second PLAU to
0 obtain a liquid mixture, and in a second step adding other of
the first or second PLAU. The latter component is preferably
added in the liquid phase at relatively high temperature
under mixing conditions which ensure fast mixing of the
components. Most preferably, the second PLAU is first added
5 to the thermoplastic resin. After homogenizing the resin and
the second PLAU, the first PLAU is added. Adding the
components in this sequence causes that the formation of
lumps in the mixtures is prevented.

0 The invention also pertains to the use of the non-reactive
hot-melt adhesive composition according to the invention to
bond substrates together. The invention thus also pertains to
a method for arranging substrates in a fixed position with
respect to each other, comprising the steps of applying an
25 amount of a non-reactive hot-melt adhesive composition as
described above in liquid form onto a surface of a first
substrate, applying a surface of a second substrate onto the
amount of non-reactive hot-melt adhesive composition, and
cooling the assembly of substrates and non-reactive hot-melt
30 adhesive composition to a temperature below the melting point
of the non-reactive hot-melt adhesive composition.

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The hot-melt adhesive compositions of this invention are suitable for adhering a wide variety of substrates together. Suitable substrates include cardboard or paper substrates, optionally provided with a layer of a polymer coating material, e.g. a polyolefin, more preferably a polyethylene, or a polylactide. Suitable substrates also include plastics, in particular objects of, e.g., polyolefins or polylactic acid, textiles, foils used in packaging, e.g., the foils used in packaging flowers or plants, but also carpet backings. Suitable substrates further include metal foils and wood.

In one embodiment, the substrates are part of a package.

Due to its biodegradability the adhesive composition according to the invention, especially where the thermoplastic resin is the copolymer of lactic acid and caprolactone described above, is particularly attractive for use in the adhesion of substrates which are in themselves biodegradable, e.g., cellulose-based substrates such as paper and cardboard, and biodegradable plastic substrates, such as substrates comprising polylactic acid polymers.

It will be clear to the skilled person that various embodiments of the present invention can be combined, unless they are mutually exclusive.

The present invention is illustrated by the following example, without being limited thereto or thereby.

Example 1

Formulations where made from the following starting materials:

As thermoplastic resin a random copolymer of caprolactone and lactic acid was used, comprising 30 wt.% of caprolactone and 70 wt.% lactic acid. The copolymer had a molecular weight M_n of 15 kg/mol. The copolymer was manufactured by ring-opening polymerization of caprolactone and lactide.

As first PLAU a PLLA (initiated with cetyl alcohol) was used with a M_n of 2.5 kg/mol.

As second PLAU a PDLA (initiated with cetyl alcohol) was used with a M_n of 3.5 kg/mol.

Three compositions were prepared, namely composition A, which contained the first PLAU but not the second PLAU and compositions B and C, both of which contain the first PLAU and different amounts of second PLAU. All compositions were prepared by mixing the thermoplastic resin with the first PLAU in the liquid phase until a homogeneous mixture was obtained, followed, for compositions B and C, by the addition of the second PLAU under stirring.

The compositions were tested in an adhesive test unit as follows: A line with a length of 140mm of the adhesive to be tested was applied at 165°C onto a cardboard substrate. After a fixed open time of 0.5 seconds, five 25mm sections of a second cardboard substrate were applied onto the adhesive with a contact speed of 0.5 m/s and kept at a pressure of 0.5kg/25mm.

After an initial assessment, the five bonds were sequentially ruptured at 1 m/s. The set time was defined as the time the bond required under pressure to ensure that upon rupture fibre tear of the cardboard substrate was obtained, while the set adhesive remained intact. Three replicate tests were made for each adhesive.

Table 1

	Thermoplastic resin (wt.%)	First PLA (wt.%)	Second PLA (wt.%)	Set time (s)
A	50	50	-	7.6
B	49.5	49.5	1	6.7
C	48.5	48.5	3	4.3

As can be seen from Table 1, all compositions show a manageable set time. Compositions B and C, which contain both the first PLAU and the second PLAU show a lower set time than Composition A. Composition C, which has a slightly higher content of second PLAU than Composition B has a set time which is even lower.

Example 2:

Formulations where made from the following starting materials:

As thermoplastic resin a random copolymer of adipic acid (40.02 wt.%), neopentyl glycol (40.02 wt.%) and lactide (29.81 wt.%) was used. The weight percentages are calculated on the amounts of monomer before synthesis. The total of the weight percentages is above 100% due to the water removal during the esterification/polymerization reaction. The copolymer had a molecular weight Mn of 8.0 kg/mol.

As first PLAU a PLLA (initiated with cetyl alcohol) was used with a Mn of 2.5 kg/mol.

As second PLAU a PDLA (initiated with cetyl alcohol) was used with a Mn of 3.5 kg/mol.

Two compositions were prepared, namely composition D, which contained the first PLAU but not the second PLAU and

composition E which contained the first PLAU and the second PLAU. The compositions were prepared and tested as described in Example 1, except that an application temperature of 160°C was used. The results are presented in Table 2 below.

Table 2

	Thermoplastic resin (wt.%)	First PLA (wt.%)	Second PLA (wt.%)	Set time (s)
D	50	50	-	8
E	48.5	48.5	3	6

As can be seen from Table 2, both compositions showed an acceptable set time, with the set time being reduced if the second PLA was added.

Throughout this specification and the claims which follow, unless the context requires otherwise, the word "comprise", and variations such as "comprises" and "comprising", will be understood to imply the inclusion of a stated integer or step or group of integers or steps but not the exclusion of any other integer or step or group of integers or steps.

The reference in this specification to any prior publication (or information derived from it), or to any matter which is known, is not, and should not be taken as an acknowledgment or admission or any form of suggestion that that prior publication (or information derived from it) or known matter forms part of the common general knowledge in the field of endeavour to which this specification relates.

The Claims Defining the Invention are as Follows:

1. Non-reactive hot-melt adhesive comprising:

- 10-90 wt.%, calculated on the weight of the adhesive, of amorphous thermoplastic resin which is compatible with polylactic acid, wherein the amorphous thermoplastic resin is a random copolymer of lactic acid and further reactive monomer; and,

- 10-90 wt.%, calculated on the weight of the adhesive, of a polylactic acid polymer unit (PLAU) selected from poly-L-lactic acid (PLLAU) and poly-D-lactic acid (PDLAU), the unit having a number average molecular weight (Mn) of at least 0.75 kg/mol,

wherein number average molecular weight (Mn) as used herein is determined by Gel Permeation Chromatography (GPC) using chloroform as solvent and running phase and polystyrene standard, and

wherein as used herein amorphous thermoplastic resin is defined as a thermoplastic resin which has an enthalpy of melting of at most 2.0 J/gram as determined by Differential Scanning Calorimetry.

2. Non-reactive hot-melt adhesive according to claim 1, which further comprises 0.5-20 wt.%, calculated on the weight of the first PLAU, of a second polylactic acid polymer unit (PLAU) selected from poly-L-lactic acid (PLLAU) and poly-D-lactic acid (PDLAU), the unit having a number average molecular weight of at least 0.75 kg/mol, wherein when the first PLAU is PLLAU, the second PLAU is PDLAU and when the first PLAU is PDLAU, the second PLAU is PLLAU.

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3. Non-reactive hot-melt adhesive according to claim 2, which further comprises 1-10 wt.%, calculated on the weight of the first PLAU, of said second polylactic acid polymer unit (PLAU).

4. Non-reactive hot-melt adhesive according to any one of claims 1 to 3, wherein the first PLAU is PLLAU and wherein the second PLAU, if present, is PDLAU.

5. Non-reactive hot-melt adhesive according to any one of claims 1 to 4, wherein the first PLAU and/or the second PLAU, if present, have a number average molecular weight in the range of 0.75 to 10 kg/mol.

6. Non-reactive hot-melt adhesive according to claim 5, wherein the first PLAU and/or the second PLAU, if present, have a number average molecular weight in the range of 1.5 to 7.5 kg/mol.

7. Non-reactive hot-melt adhesive according to any one of claims 1 to 6, wherein the amorphous thermoplastic resin has a Mn in the range of 10 to 100 kg/mol.

8. Non-reactive hot-melt adhesive according to claim 7, wherein the amorphous thermoplastic resin has a Mn in the range of 10 to 30 kg/mol.

9. Non-reactive hot-melt adhesive according to any one of claims 1 to 8, which comprises 20-80 wt.%, calculated on the weight of the adhesive, of amorphous thermoplastic resin and 20-80 wt.%,

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calculated on the weight of the adhesive, of the total of first and second PLA units.

10. Non-reactive hot-melt adhesive according to claim 9, which comprises 30-70 wt.%, calculated on the weight of the adhesive, of amorphous thermoplastic resin and 30-70 wt.%, calculated on the weight of the adhesive, of the total of first and second PLA units.

11. Non-reactive hot-melt adhesive according to claim 9, which comprises 40-60 wt.%, calculated on the weight of the adhesive, of amorphous thermoplastic resin and 40-60 wt.%, calculated on the weight of the adhesive, of the total of first and second PLA units.

12. Non-reactive hot-melt adhesive according to any one of claims 1 to 11, wherein the random copolymer of lactic acid and a further reactive monomer comprises 10-90 wt.% of lactic acid monomer and 90-10 wt.% of further reactive monomers.

13. Non-reactive hot-melt adhesive according to claim 12, wherein the random copolymer of lactic acid and a further reactive monomer comprises at least 40 wt.% of lactic acid monomer.

14. Non-reactive hot-melt adhesive according to claim 12, wherein the random copolymer of lactic acid and a further reactive monomer comprises at least 80 wt.% of lactic acid monomer.

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15. Non-reactive hot-melt adhesive according to any one of claims 1 to 14, wherein the further reactive monomer comprises caprolactone.

16. Non-reactive hot-melt adhesive according to claim 15, wherein the copolymer of lactic acid monomer and caprolactone has a Mn in the range of 10 to 50 kg/mol.

17. Non-reactive hot-melt adhesive according to claim 15 or claim 16, wherein the non-reactive hot-melt adhesive comprises 40-60 wt.%, calculated on the weight of the adhesive, of amorphous thermoplastic resin and 40-60 wt.%, calculated on the weight of the adhesive, of first and, if present, second PLA units.

18. Non-reactive hot-melt adhesive according to any one of claims 1 to 17, wherein the thermoplastic resin and the polylactic acid polymer units together make up at least 50 wt.% of the adhesive.

19. Non-reactive hot-melt adhesive according to claim 18, wherein the thermoplastic resin and the polylactic acid polymer units together make up at least 80 wt.% of the adhesive.

20. Method for manufacturing a non-reactive hot-melt adhesive according to any one of claims 1 to 19, comprising the steps of combining and mixing the thermoplastic resin, the first PLAU, and, if present the second PLAU, to form a liquid composition.

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21. Method according to claim 20, wherein in a first step the thermoplastic resin and one of the first or second PLAU are combined to obtain a liquid mixture, and in a second step the other of the first or second PLAU is added to form a homogeneous mixture.

22. Method according to claim 21, wherein in a first step the thermoplastic resin and one of the first or second PLAU are combined to obtain a liquid mixture, and in a second step the other of the first or second PLAU is added, with the latter component being added in the liquid phase, to form a homogeneous mixture.

23. Method for arranging substrates in a fixed position with respect to each other, comprising the steps of:

applying an amount of a non-reactive hot-melt adhesive according to any one of claims 1 to 19 in liquid form onto a surface of a first substrate;

applying a surface of a second substrate onto the amount of non-reactive hot-melt adhesive; and,

cooling the assembly of substrates and non-reactive hot-melt adhesive to a temperature below the melting point of the non-reactive hot-melt adhesive.